

CAPABILITIES STATEMENT

Point of Contact - Sales

Guilford Cantave
President & CEO
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Website

<https://www.fermitron.com>

NAICS Codes

541330: Engineering Services
(Hardware Design)
334418: Printed Circuit Assembly
(Electronic Assembly)
Manufacturing (CCA)
334412: Bare Printed Circuit
Board Manufacturing (PWB)
334419: Other Electronic
Component Manufacturing
541690: Other Scientific and
Technical Consulting Services

CAGE Code

63BM9

UEI

JMGRD74E1WK5

Certifications / Verifications

VA: SDVOSB (Vets First/CVE)
FDOT: DBE
Florida: MBE/VBE
DLA JCO: JCP



Core Competencies

FermiTron, Inc. is a full-service, custom electronic product design and manufacturing corporation which provides value added support and services to companies and government entities.

Our team of engineers and technicians have the capability to provide full turnkey product development or targeted assistance on a project responding to customer needs.

Value added services provided by FermiTron include:

- Custom Electronic Circuit Design ■ Printed Circuit Board Layout
- Firmware Development ■ Rapid Prototype Circuit Card Assembly
- Cable Assemblies ■ Circuit Card Rework/Repair ■ Production Support
- Reverse Engineering ■ Production Circuit Card Assembly ■ Box Builds

Differentiators

■ We deliver high-quality electronic product development design and manufacturing solutions that enable clients to meet business goals more effectively. ■ We maintain an environment of high integrity, quality, commitment and responsiveness ■ FermiTron is flexible, fast and nimble hence able to service clients changing needs.

Past Performance

- **SOFWERX/USSOCOM:** Performed firmware development and electrical engineering services including, circuit schematic capture, PCB layout, circuit board assembly and testing to support the rapid prototyping of several subsystems of the "Tactical Assault Light Operator Suit" (TALOS) project.
- **Unisys Corporation/NASA:** Assisted NASA engineers by performing design, PCB layout, circuit board assembly and testing for several flight simulator subsystems under the "Langley Simulation and Aircraft Technical Services" (LSATS) contract.
- **Powerlase Photonics, Inc.:** Managed the procurement of PCBs and the associated components for several subsystems of a high power laser. Assembled, inspected and performed unit testing with the goal of assisting the Powerlase Photonics engineering team with their product launch.

- **Defense - US NAVY, Collins Aerospace, Boeing, Raytheon:** Performed various Printed Circuit Board Assembly (PCBA), Cable Assembly and Box Build Assembly projects as the prime contractor or subcontractor completing said projects on time and on budget.